

WSE3088

N-Ch MOSFET

#### **General Description**

The WSE3088 is the highest performance trench N-Ch MOSFET with extreme high cell density , which provide excellent  $R_{\text{DSON}}$  and gate charge for most of the synchronous buck converter applications .

The WSE3088 meet the RoHS and Green Product requirement with full function reliability approved.

#### Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

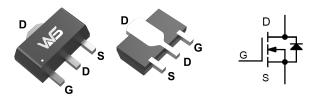
#### **Product Summery**

BVDSS	RDSON	ID
30V	23mΩ	7A

#### Applications

- High Frequency Point-of-Load Synchronous s Small power switching for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

#### **SOT-89 Pin Configuration**



### **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	30	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I₀@Tc=25℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	7.0	A
I <sub>D</sub> @T <sub>C</sub> =70℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	5.5	A
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	28	A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	9	mJ
I <sub>AS</sub>	Avalanche Current	6	A
P <sub>D</sub> @T <sub>A</sub> =25℃	Total Power Dissipation <sup>4</sup>	1.8	W
T <sub>STG</sub>	Storage Temperature Range -55 to 150		°C
TJ	Operating Junction Temperature Range -55 to 150		°C

#### **Thermal Data**

Symbol	Parameter	Typ. Max.		Unit	
R <sub>eJA</sub>	Thermal Resistance Junction-ambient <sup>1</sup>		70	°C/W	
R <sub>θJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		30	°C/W	



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#### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to $25^\circ\!\!\mathbb{C}$ , I_D=1mA		0.023		V/℃
Р	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =4.5V , I <sub>D</sub> =7A		23	28	
R <sub>DS(ON)</sub>		V <sub>GS</sub> =2.5V , I <sub>D</sub> =6A		31	38	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage		0.5	1.0	1.5	V
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	──V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA		-4.2		mV/℃
	Drain Source Lookage Current	$V_{DS}$ =24V , $V_{GS}$ =0V , $T_{J}$ =25 $^{\circ}$ C			1	— uA
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =24V , $V_{GS}$ =0V , T <sub>J</sub> =55 $^{\circ}$ C			5	
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm20V$ , $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =6A		7		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		2.5	5.0	Ω
Qg	Total Gate Charge (4.5V)			8.0	10.5	
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =10V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =7A		0.7		nC
Q <sub>gd</sub>	Gate-Drain Charge			1.5		
T <sub>d(on)</sub>	Turn-On Delay Time			4	7.5	
Tr	Rise Time	V <sub>DD</sub> =10V ,V <sub>GS</sub> =10V,		12.5	23	
T <sub>d(off)</sub>	Turn-Off Delay Time			13.5	25	ns
T <sub>f</sub>	Fall Time			2	3.5	
Ciss	Input Capacitance	V <sub>DS</sub> =10V , V <sub>GS</sub> =0V , f=1MHz		360	730	
C <sub>oss</sub>	Output Capacitance			80	112	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			55	65	

#### **Guaranteed Avalanche Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy $^5$	V <sub>DD</sub> =25V , L=0.5mH , I <sub>AS</sub> =6A	7			mJ

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,6</sup>				2	А
I <sub>SM</sub>	Pulsed Source Current <sup>2,6</sup>	$V_G=V_D=0V$ , Force Current			28	А
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =3A , TJ=25℃			1.3	V
t <sub>rr</sub>	Reverse Recovery Time			8.5		nS
Qrr	Reverse Recovery Charge	lَF=7A , dl/dt=100A/μs , T <sub>J</sub> =25℃		2.5		nC

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper, t $\leq$ 10sec.

2.The data tested by pulsed , pulse width  $\,\leq\,$  300us , duty cycle  $\,\leq\,$  2%

3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.5mH,  $I_{AS}$ =6A

4.The power dissipation is limited by 150  $^\circ\!\mathrm{C}$  junction temperature

5. The Min. value is 100% EAS tested guarantee.

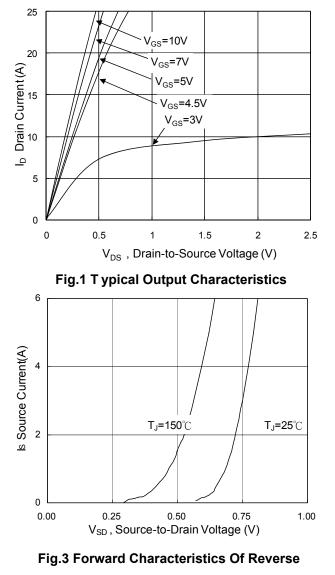
6. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications , should be limited by total power dissipation.



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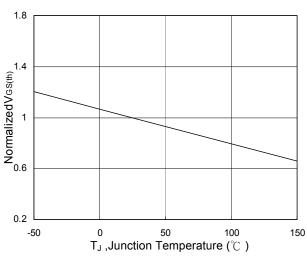


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$ 

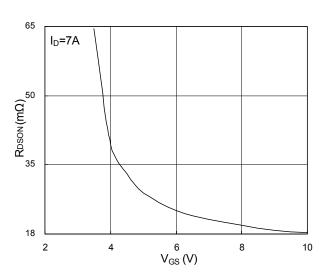


Fig.2 On-Resistance vs. Gate-Source

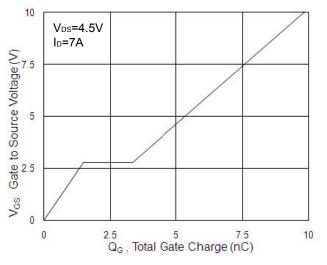
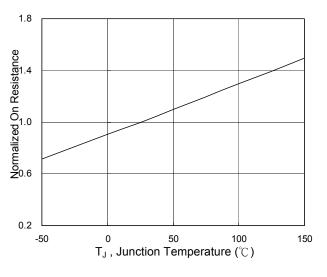


Fig.4 Gate-Charge Characteristics





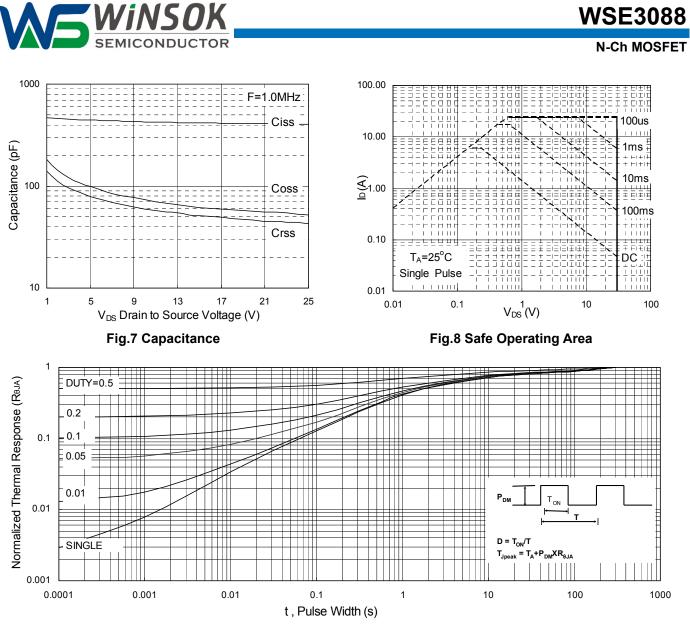
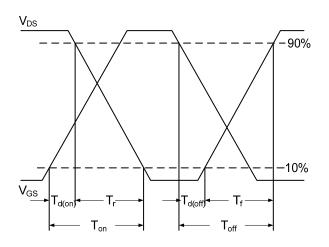


Fig.9 Normalized Maximum Transient Thermal Impedance





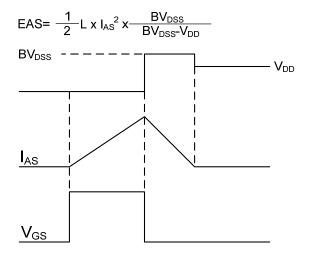


Fig.11 Unclamped Inductive Switching Waveform



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